



APPLICATIONS

Wireless Network
Telecom/Datacom
Industry Control System
Distributed Power Architectures
Semiconductor Equipment
Microprocessor Power Applications

FEATURES

- OUTPUT CURRENT UP TO 6A
- SMALL SIZE AND LOW PROFILE :
0.80" X 0.45" X 0.22" (SMD) ; 0.9" X 0.40" X 0.20" (SIP)
- HIGH EFFICIENCY - 94% @ 3.3V FULL LOAD
- INPUT RANGE FROM 2.4VDC TO 5.5VDC
- FIXED SWITCHING FREQUENCY (300KHZ)
- SMD & SIP PACKAGES
- OUTPUT VOLTAGE PROGRAMMABLE FROM 0.75VDC TO 3.3VDC VIA EXTERNAL RESISTOR
- INPUT UNDER-VOLTAGE LOCKOUT
- UL60950-1, EN60950-1 AND IEC60950-1 LICENSED
- ISO9001 CERTIFIED MANUFACTURING FACILITIES
- COMPLIANT TO RoHS EU DIRECTIVE 2002/95/EC

1 / 3

OPTIONS

Positive Logic Remote on/off

DESCRIPTION

DOS06-05T (SMD type), DOH06-05T (for Vertical Mounting SIP type) and DOH06-05TA (for Horizontal Mounting SIP type) are non-isolated DC/DC converters that can deliver up to 6A of output current with full load efficiency of 94% at 3.3V output.

TECHNICAL SPECIFICATION

All specifications are typical at nominal input, full load and 25°C otherwise noted

OUTPUT SPECIFICATIONS

Output current	6A max
Voltage accuracy	Full load and Vin(min) ± 2%Vo(set)
Minimum load	0%
Line regulation	Vin=Vo(set)+0.5V to Vin(max) at Full Load ± 0.3%Vo(set),typ
Load regulation	No Load to Full Load ± 0.4%Vo(set),typ
Ripple and noise (Note2)	20MHz bandwidth 20mVrms,max 50mVp-p,max
Temperature coefficient	±0.4%, typ
Dynamic load response (Note2)	△Io / △t = 2.5A/uS ,Vin(nom) Peak deviation 130mV,typ Load change step (50% to 100% or 100% to 50% of Io(max)) Setting time (Vo<10%peak deviation) 25uS,typ
Dynamic load response (Note3)	△Io / △t = 2.5A/uS ,Vin(nom) Peak deviation 50mV,typ Load change step (50% to 100% or 100% to 50% of Io(max)) Setting time (Vo<10%peak deviation) 50uS,typ
Output current limit	220%,typ
Output short-circuit current	Hiccup, automatics recovery
External load capacitance	ESR ≥ 1mΩ 1000uF,max ESR ≥ 10mΩ 3000uF,max
Output voltage overshoot-startup	Vin=2.4~5.5V, F.L. 1%Vo(set)
Voltage adjustability (see fig.1)	(Note 4) 0.7525V ~ 3.63V

GENERAL SPECIFICATIONS

Efficiency	See table
Isolation voltage	None
Switching frequency	300KHz, typ
Approvals and standard	IEC60950-1, UL60950-1, EN60950-1
Dimensions	SMD 0.80 X 0.45 X 0.22 Inch (20.3 X 11.4 X 5.5 mm) SIP 0.90 X 0.40 X 0.20 Inch (22.9 X 10.2 X 5.0 mm)
Weight	2.8g(0.1oz)
MTBF (Note 1)	BELLCORE TR-NWT-000332 2.133 x 10 ⁷ hrs MIL-HDBK-217F 3.247 x 10 ⁶ hrs

INPUT SPECIFICATIONS

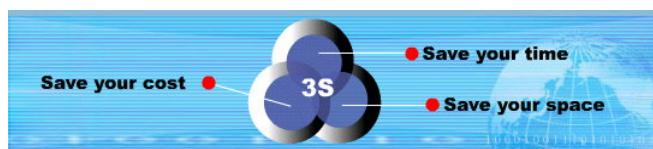
Input voltage range	Vo(set) < Vin – 0.5V	2.4 – 5.5VDC
Maximum input current	Vin=Vin(min); Vo(set)=3.3V; Io=Io(max)	6A
Input filter (Note 5)		C filter
Input no load current (Vin=5V, Io=0, module enabled)	Vo(set) =0.75Vdc Vo(set) =3.3Vdc	20mA,typ 45mA,typ
Input under voltage lockout	Start-up voltage Shutdown voltage	2.2V,typ 2.0V,typ
Input reflected ripple current	5~20MHz, 1uH source impedance	35mAp-p

ENVIRONMENTAL SPECIFICATIONS

Operating temperature range	–40°C ~ +85°C (with derating)	
Storage temperature range	–55°C ~ +125°C	
Thermal shock	MIL-STD-810F	
Over temperature protection	135 °C, typ	

FEATURE SPECIFICATIONS

Remote ON/OFF(Note 6)	ON = 0V < Vr < 0.3V	I _{IN} =10 μ A,max
(Negative logic)(standard)	OFF =1.5V < Vr < Vin(max)	I _{IN} =1mA,max
(Positive logic)(option)	ON = Vin(max)	I _{IN} =10 μ A,max
	OFF=0V < Vr < 0.3V	I _{IN} =1mA,max
Input current of Remote control pin		10μA~1.0mA
Remote off state input current	Nominal Vin	0.6mA,typ
Rise time	Time for Vo to rise from 10% to 90%of Vo(set)	6ms,max.
Turn-on delay time	Case 1 (Note 7) Case 2 (Note 8)	1ms, typ 1ms, typ





Model Name	ON/OFF Logic	Package	Input Voltage	Output Voltage	Output Current		Efficiency (%) 5.0Vin, 3.3Vdc@6A
					Min. Load	Max. Load	
DOS06-05T	Negative	SMD			0A	6A	
DOH06-05T-P	Positive						
DOH06-05T	Negative	Vertical Mounting	2.4 ~ 5.5Vdc	0.75 ~ 3.3Vdc			94%
DOH06-05T-P	Positive	SIP	Vin(min)=Vo(set)+0.5V				
DOH06-05TA	Negative	Horizontal Mounting					
DOH06-05TA-P	Positive	SIP					

Note

1. BELLCORE TR-NWT-000332. Case 1: 50% Stress, Temperature at 25°C.
2. MIL-HDBK-217F Notice2 @Ta=25 °C, Full load(Ground, Benign, controlled environment).
3. External with $C_{out} = 1\mu F$ ceramic//100 μF tantalum capacitors.
4. External with $C_{out} = 2 \times 150\mu F$ polymer capacitors.
5. Output voltage programmable from 0.75V to 3.3V by connecting a single resistor (shown as Rtrim in Table 1) between the TRIM and GND pins of the module. To calculate the value of the resistor **Rtrim** for a particular output voltage **Vo**, use the following equation:

$$R_{trim} = \left[\frac{21070}{V_o - 0.7525} - 5110 \right] \Omega$$

6. It's necessary to equip the external input capacitors at the input of the module. The capacitors should connect as close as possible to the input terminals that ensuring module stability. The external C_{in} is $2 \times 150\mu F$ low-ESR polymer capacitors // $2 \times 47\mu F$ ceramic capacitors at least.
7. Device code with suffix “-P” – Positive logic(On/Off is open collector/drain logic input; Signal referenced to GND)
8. Device code with no suffix – Negative logic (On/Off pin is open collector/drain logic input with external pull –up resistor; signal referenced to GND)
9. Case 1 :On/Off input is set to logic low (module on) and then input power is applied (delay from instant at which $Vin=Vin(min)$ until $Vo=10\%$ of $Vo(set)$)
10. Case 2 :Input power is applied for at least one second and then the On/Off input is set to logic low (delay form instant at which Von/off=0.3V until $Vo=10\%$ of $Vo(set)$)

CAUTION: This power module is not internally fused. An input line fuse must always be used.

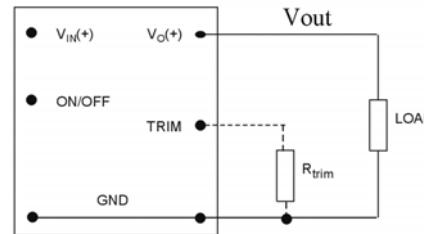
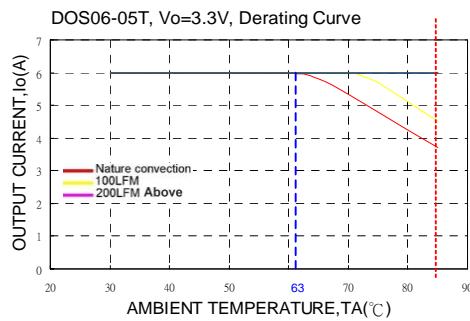


Fig. 1

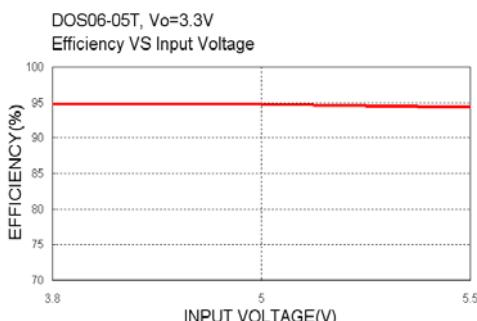
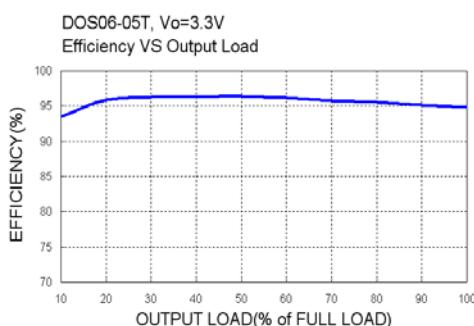
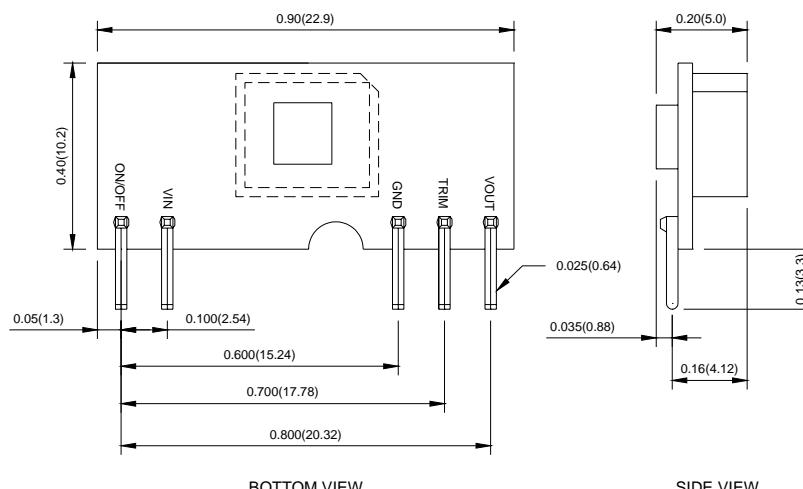


Table 1	
Vo(set) (V)	Rtrim (KΩ)
0.7525	Open
1.2	41.973
1.5	23.077
1.8	15.004
2.5	6.974
3.3	3.160

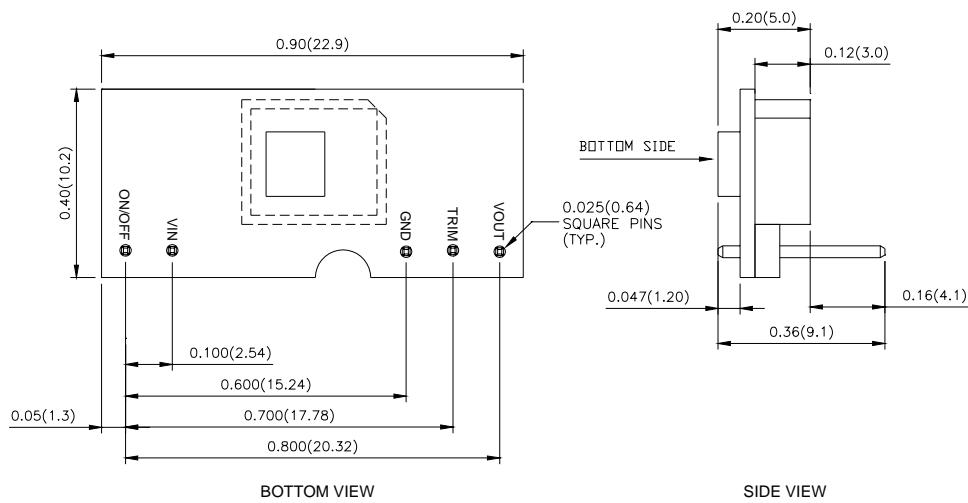




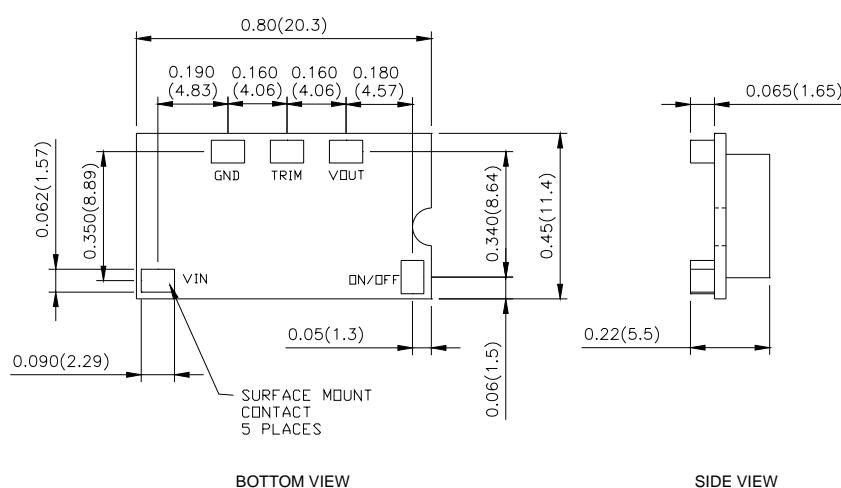
DOH06-05T



DOH06-05TA



DOS06-05T



1. All dimensions in Inches (mm)
Tolerance: X.XX±0.02 (X.X±0.5)
X.XXX±0.01 (X.XX±0.25)
2. Pin pitch tolerance ±0.01(0.25)
3. Pin dimension tolerance ±0.004 (0.1)